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201 Washington Rd.
Princeton, NJ 08540

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Bldg. NW-14
Massachusetts Inst. Technol.
Cambridge, MA 02133

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U.S. Army Electronics Cmd.
Fort Monmouth, NJ 07703

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Dept. Elec. Eng.
Univ. Texas
Arlington, TX 76019

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W. E. HORD

Microwave Systems

J. B. HORTON
TRW 92/3166
One Space Park
Redondo Beach, CA 90278

Microwave Network Theory

A. E. WILLIAMS
COMSAT LABS
22300 Comsat Dr.
Clarksburg, MD 20734

Microwave Acoustics

R. S. KAGIWADA
TRW Defense and Space Systems
Elec. Syst. Div.
One Space Park
Redondo Beach, CA 90278

Microwave High-Power Techniques

J. GOEL
TRW Defense and Space Systems
One Space Park
Redondo Beach, CA 90278

Biological Effects and Medical Applications

J. C. LIN
Dept. Bio.-Eng.
Univ. Illinois, Chicago
Box 4348
Chicago, IL 60680

Microwave Low Noise Techniques

J. J. WHELEHAN, JR.
Eaton Corp. AIL Div.
Walt Whitman Rd.
Melville, NY 11747

Digital Signal Processing

I. A. MACK
Naval Res. Lab.
4555 Overlook Ave. SW
Washington, DC 20375

Fiber and Integrated Optics

Microwave and Millimeter-Wave Integrated Circuits

D. P. HORNBuckle
Hewlett-Packard Co.
1412 Fountain Grove Pkwy.
Santa Rosa, CA 95401

Microwave Measurements

S. F. ADAM
Adam Microwave Consulting Inc.
1413 Brookmill Rd.
Los Altos, CA 94022

Microwave Field Theory

T. ITOH
Dept. Elec. Eng.
Univ. Texas, Austin, Box 7728
Austin, TX 78712

Automatic RF Techniques

M. A. MAURY, JR.
Maury Microwave Corp.
8610 Helms Ave.
Cucamonga, CA 91730

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